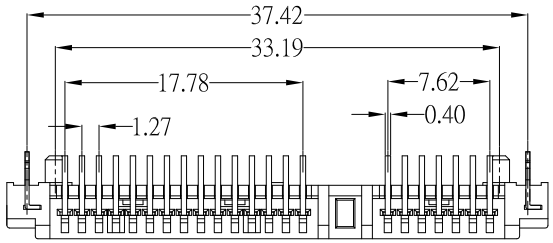

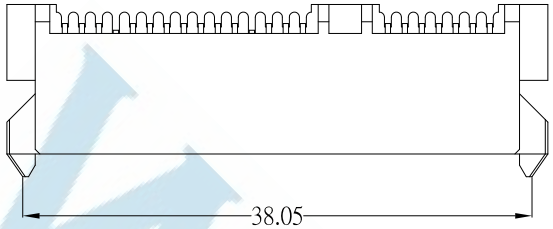

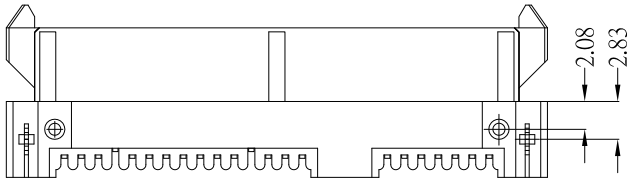

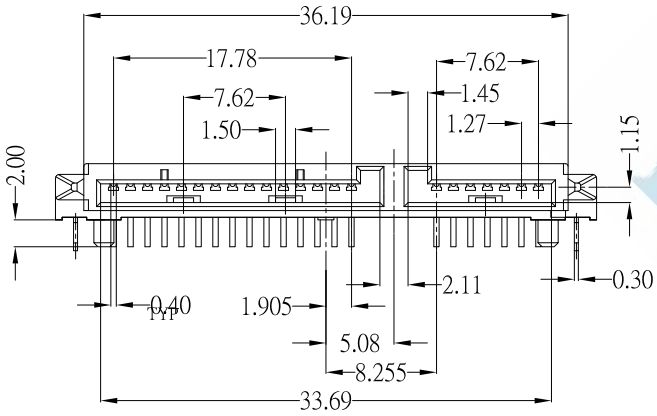

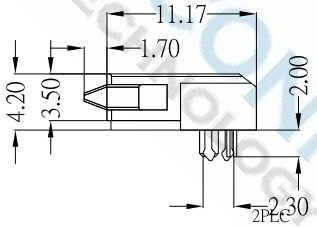

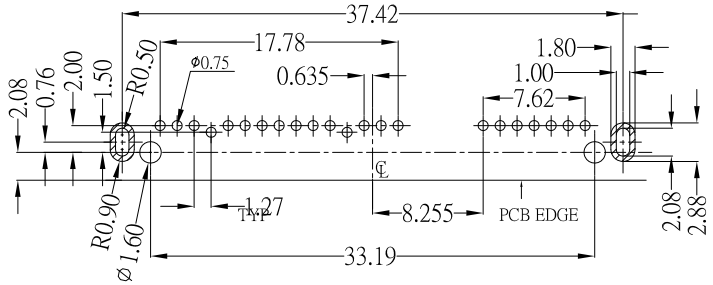

RECOMMENDED PCB LAYOUT

SPECIFICATION:

1.MATERIAL:

1.1 HOUSING: LCP , UL 94V-0 , Black.

1.2 CONTACT: PHOSPHOR BRONZE

1.3 BOARD LOCK: BRASS

2.Finish:

2.1 CONTACT: PLATED GOLD IN MATING AREA ;
TIN PLATED ON SOLDER BALLS ;
NICKEL UNDER PLATED OVERALL

2.2 BOARD LOCK: TIN PLATED ON SOLDER BALLS ;
NICKEL UNDER PLATED OVERALL

WISCONN Technology

DIMENSIONS TOLERANCE METRIC .0=±0.30 .00=±0.20 .000=±0.10 ANG.=±2°	單位(UNITS)	MM	處理(FINISH)	SEE NOTE	審校(CH'K)	Calvin	圖名(NAME) SATA 7+15P 母座 DIP H4.20 板上型	WISCONN Technology Co.,Ltd
	數量(QT'Y)	N/A	繪圖(DRAW)	Johnson	核准(APP'D)	Selena	料號(PART NUMBER) WSTA-22xxLBDUR-4.2	Tel:02-2790-1979 Fax:02-2790-1569
	材料(MT'L)	SEE NOTE	設計(DE'N)	Mike	日期(DATE)	AUG.19.2015	圖號(DRAW NUMBER) T002	比例(SCALE) 1/1 圖紙(SIZE) A4 頁次(SHEET) 1 版次(REV.) A
							圖檔(FILE NAME .DWG)	